

N-Channel Enhancement Mode Field Effect Transistor

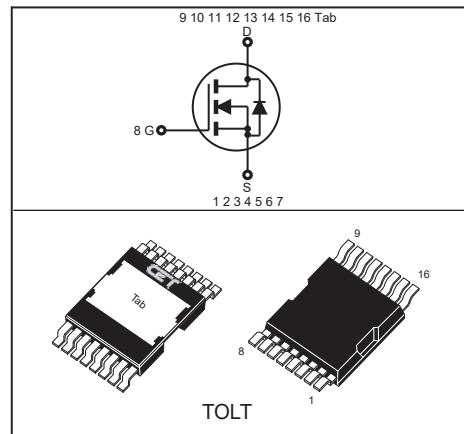
FEATURES

- High power and current handing capability.
- Reliable and rugged.
- Excellent figure of merit.
- Pb-free lead plating ; RoHS compliant.
- Halogen Free.

APPLICATIONS

- Battery management.
- Load switch.
- Telecom hotswap.

V_{DSS}	$R_{DS(ON)} \text{ typ}$	I_D	$@V_{GS}$
135V	1.7mΩ	353A	10V



ABSOLUTE MAXIMUM RATINGS $T_C = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Limit	Units
Drain-Source Voltage	V_{DS}	135	V
Gate-Source Voltage	V_{GS}	± 20	V
Drain Current-Continuous@ $T_C = 25^\circ\text{C}$	I_D	353	A
@ $T_C = 70^\circ\text{C}$		296	A
Drain Current-Pulsed ^a	I_{DM}	1412	A
Maximum Power Dissipation @ $T_C = 25^\circ\text{C}$	P_D	577	W
- Derate above 25°C		3.84	W/ $^\circ\text{C}$
Single Pulsed Avalanche Energy ^d	E_{AS}	1404	mJ
Single Pulsed Avalanche Current ^d	I_{AS}	53	A
Operating and Store Temperature Range	T_J, T_{stg}	-55 to 175	$^\circ\text{C}$

Thermal Characteristics

Parameter	Symbol	Limit	Units
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	0.26	$^\circ\text{C/W}$
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	60	$^\circ\text{C/W}$



CELT355N13

Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Test Condition	Min	Typ	Max	Units
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	135			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}} = 135\text{V}, V_{\text{GS}} = 0\text{V}$		1		μA
Gate Body Leakage Current, Forward	I_{GSSF}	$V_{\text{GS}} = 20\text{V}, V_{\text{DS}} = 0\text{V}$		100		nA
Gate Body Leakage Current, Reverse	I_{GSSR}	$V_{\text{GS}} = -20\text{V}, V_{\text{DS}} = 0\text{V}$		-100		nA
On Characteristics^b						
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{GS}} = V_{\text{DS}}, I_D = 250\mu\text{A}$	2		4	V
Static Drain-Source On-Resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 10\text{V}, I_D = 80\text{A}$		1.7	2.2	$\text{m}\Omega$
Gate input resistance	R_g	f=1MHz,open Drain		1.3		Ω
Dynamic Characteristics^c						
Input Capacitance	C_{iss}	$V_{\text{DS}} = 65\text{V}, V_{\text{GS}} = 0\text{V}, f = 1.0 \text{ MHz}$		8855		pF
Output Capacitance	C_{oss}			3245		pF
Reverse Transfer Capacitance	C_{rss}			75		pF
Switching Characteristics^c						
Turn-On Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 65\text{V}, I_D = 20\text{A}, V_{\text{GS}} = 10\text{V}, R_{\text{GEN}} = 3\Omega$		51		ns
Turn-On Rise Time	t_r			21		ns
Turn-Off Delay Time	$t_{\text{d}(\text{off})}$			89		ns
Turn-Off Fall Time	t_f			30		ns
Total Gate Charge	Q_g	$V_{\text{DS}} = 65\text{V}, I_D = 20\text{A}, V_{\text{GS}} = 10\text{V}$		110		nC
Gate-Source Charge	Q_{gs}			27		nC
Gate-Drain Charge	Q_{gd}			35		nC
Drain-Source Diode Characteristics and Maximum Ratings						
Drain-Source Diode Forward Current	I_s				353	A
Drain-Source Diode Forward Voltage ^b	V_{SD}	$V_{\text{GS}} = 0\text{V}, I_s = 2\text{A}$			1.2	V
Reverse Recovery Time	T_{rr}	$I_F = 80\text{A}, di/dt = 100\text{A}/\mu\text{s}$		131		ns
Reverse Recovery Charge	Q_{rr}			304		nC
Notes : a.Repetitive Rating : Pulse width limited by maximum junction temperature b.Pulse Test : Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$. c.Guaranteed by design, not subject to production testing. d.L = 1mH, $I_{AS} = 53\text{A}$, $V_{DD} = 60\text{V}$, $R_G = 25\Omega$, Starting $T_J = 25^\circ\text{C}$.						

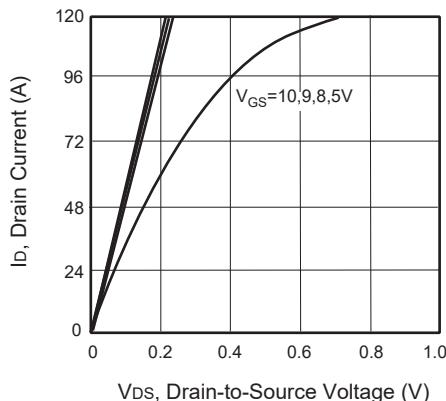


Figure 1. Output Characteristics

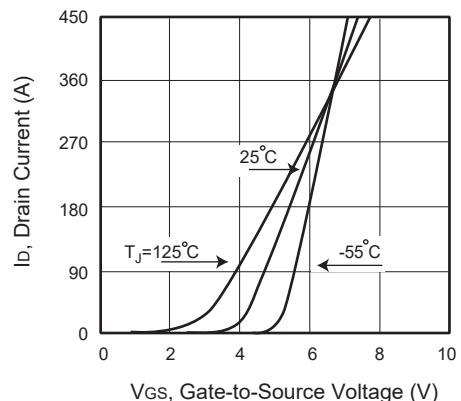


Figure 2. Transfer Characteristics

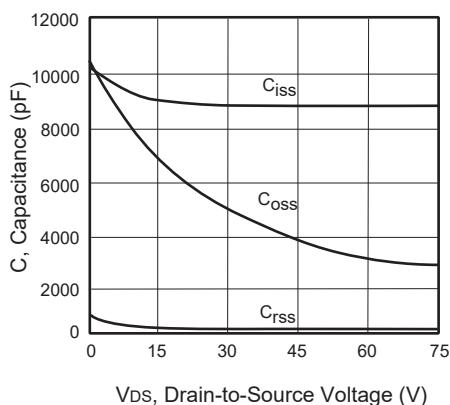


Figure 3. Capacitance

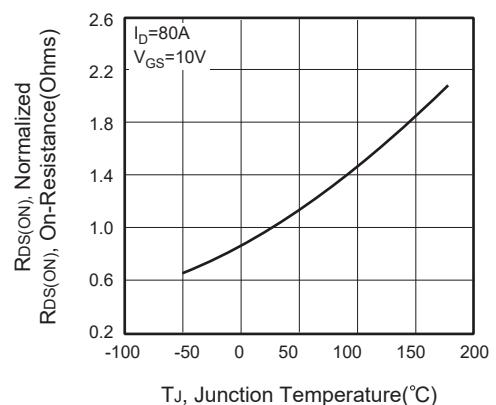


Figure 4. On-Resistance Variation with Temperature

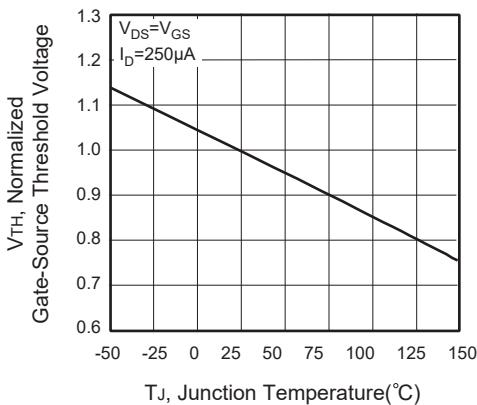


Figure 5. Gate Threshold Variation with Temperature

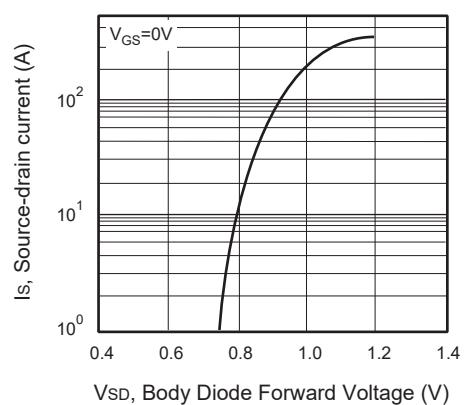


Figure 6. Body Diode Forward Voltage Variation with Source Current

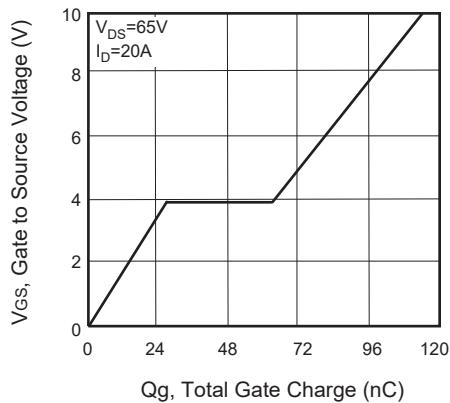


Figure 7. Gate Charge

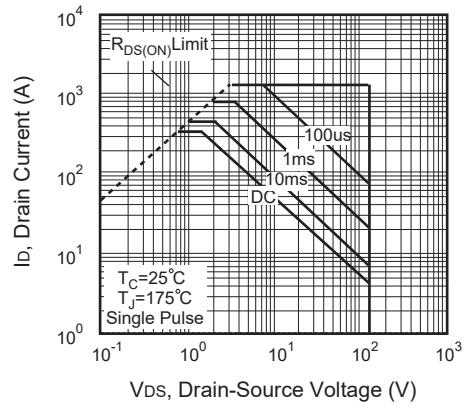


Figure 8. Maximum Safe Operating Area

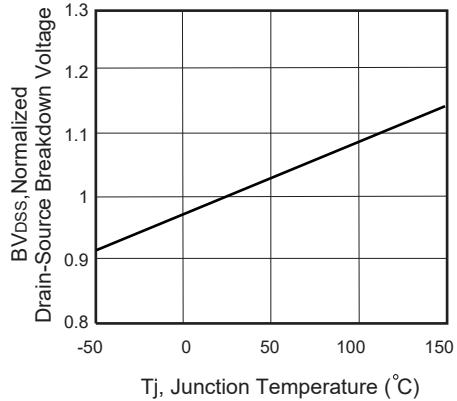


Figure 9. Breakdown Voltage Variation VS Temperature

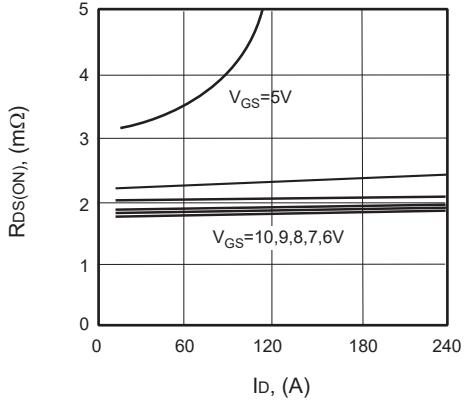


Figure 10. On-Resistance vs. Drain Current

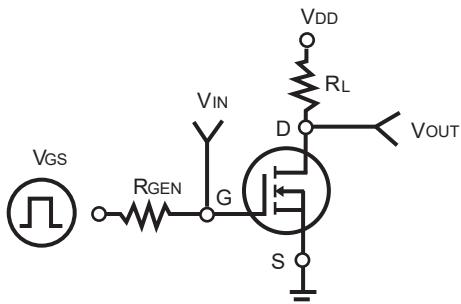


Figure 11. Switching Test Circuit

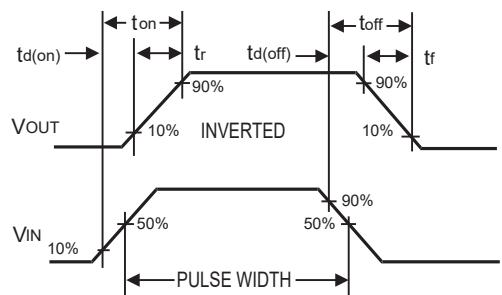
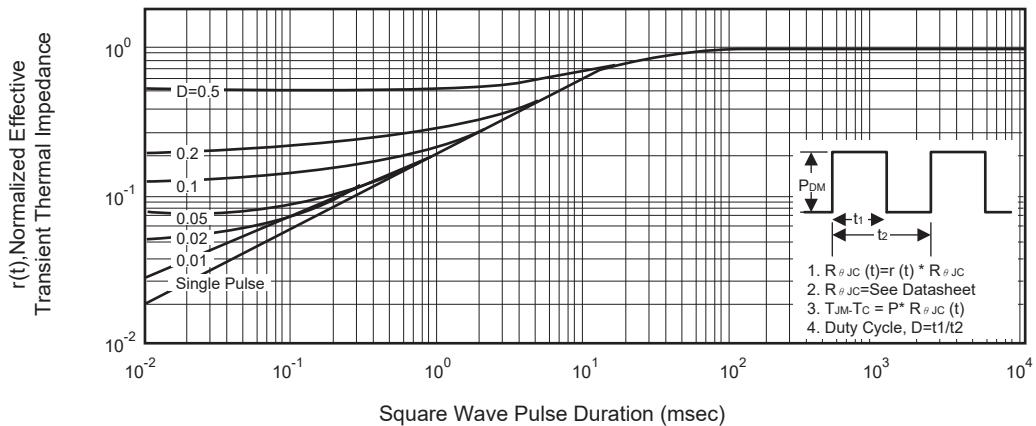


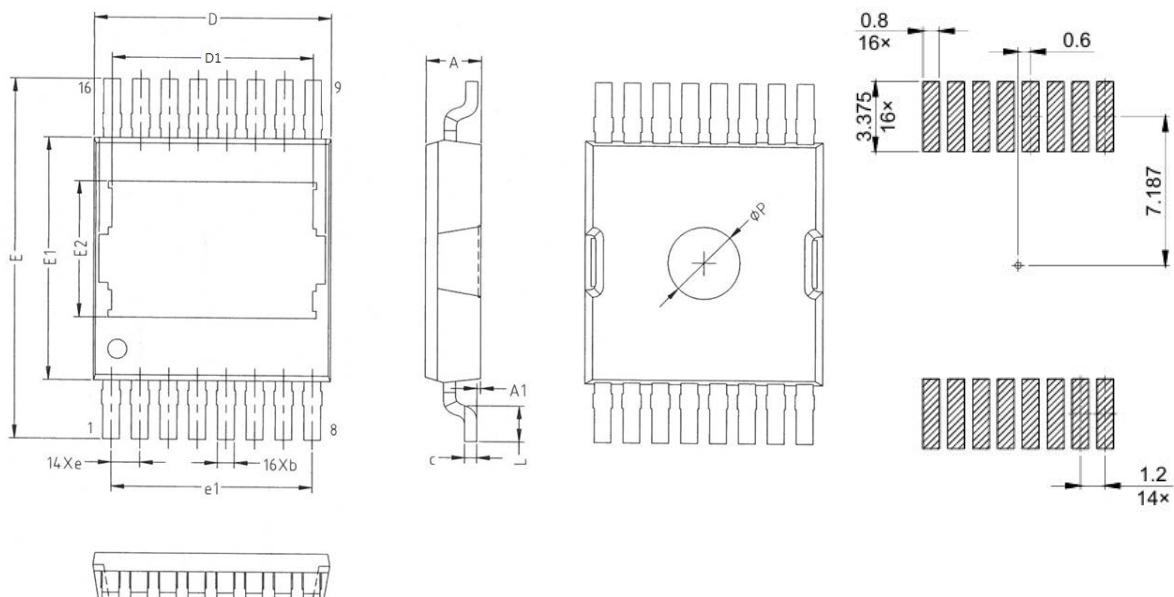
Figure 12. Switching Waveforms

**Figure 13. Normalized Thermal Transient Impedance Curve**



CELT355N13

TOLT 產品外觀尺寸圖 (Product Outline Dimension)



SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	2.250	2.350	0.089	0.093
A1	0.010	0.160	0.000	0.006
b	0.600	0.800	0.024	0.031
c	0.400	0.600	0.016	0.024
D	9.700	10.100	0.382	0.398
D1	8.300	8.500	0.327	0.335
E	14.800	15.200	0.583	0.598
E1	10.000	10.300	0.394	0.406
E2	5.570	5.770	0.219	0.227
e	1.20BSC		0.047BSC	
e1	8.40BSC		0.331BSC	
L	1.400	1.600	0.055	0.063
P	2.900	3.100	0.114	0.122